

CUSTOM

MSSR

ISSR

Product Overview

EMR

COAX



TELEDYNE RELAYS
TELEDYNE COAX SWITCHES
Everywhereyoulook™

SPACE

MATRIX

InP



Switching Solutions

Teledyne Relays is the world's innovative leader in manufacturing ultra-miniature hermetically sealed switching products, with more than 50 years heritage in military programs. Our comprehensive product line meets wide-ranging requirements for the defense, space and aerospace markets, covering frequencies from DC to 67GHz with our coaxial products, and DC-18GHz with signal integrity up to 40Gbps with our high-frequency electro-mechanical relays. We also offer high-performance solutions for industrial, telecom, commercial, and medical switching applications.

Business Focus

- QPL & COTS Electromechanical Relays
- QPL & COTS Solid-State Relays
- Industrial Solid-State Relays
- High-Frequency Relays and Coaxial Switches
- Space (Hi-Rel) Relays & Coaxial Switches
- COTS & Custom RF Switch Matrices
- Military and Space Grade Optocouplers
- Hybrid Solutions, SSPC, DC-DC Converters

Markets We Serve

- Commercial & Military Aviation
- Defense, Space & Aerospace
- Telecom/Communications (Wireless)
- Instrumentation & Test
- Industrial Power & Motion Control
- Medical Applications
- IC Semiconductor Test
- Oil & Gas

Product Assurance & Technical Service



Under an aggressive Total Quality Management (TQM) program, Teledyne Relays has embraced a “continuous improvement” culture. With recognized certifications such as AS/EN/JISQ9100:2009 (REV D), ISO 9001/2015, DSCC MIL-STD-790 and Boeing D6-82479, Teledyne Relays has become a primary supplier of switching solutions with the highest quality and reliability to industry leaders around the world.

Teledyne Relays provides easy access to technical service and customer support. An innovative, integrated website makes it easy to find technical information, buy relays and even get e-mail responses within 24 hours. Design engineers who need switching solutions for their electronic systems can find them available on our website.



High Performance Switches For Your High-Frequency Application



Teledyne Relays offers low signal, hermetic, electromechanical relays for high-reliability applications across multiple markets.



RF RELAYS

- Signal Integrity up to 40Gbps
- DC - 18GHz
- SPDT Non Latch & Latching
- Hermetically Sealed
- 3 Million Cycle Life



RF Performance			
Frequency (GHz)	VSWR	Isolation (dB)	Insertion Loss (dB)
DC-4	1.20:1	65	0.12
4-8	1.25:1	50	0.15
8-12	1.28:1	45	0.20
12-16	1.75:1	40	0.50
16-18	1.95:1	30	0.85

[Link to datasheet](#)

SPDT



GRF121
DC-18 GHz
40 Gbps



GRF131
DC-18 GHz
40 Gbps

DPDT



SRF303
DC-6 GHz
18 Gbps



SGRF312
DC-8 GHz
20 Gbps

LOOPBACK

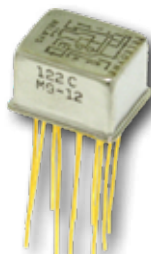


SGLB363
DC-6 GHz
16Gbps



COMMERCIAL RELAYS

LATCHING



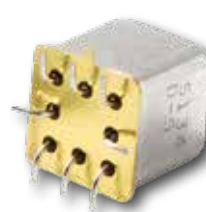
122C



722

- Economical Switching Solutions
- Short Lead Times
- Hermetically Sealed
- 10 Million Cycle Life
- 1A/28Vdc Resistive Load Rating
- Transistor and CMOS driver options

NON-LATCHING



S134



172

HIGH PERFORMANCE RELAYS

HIGH TEMPERATURE

- -65°C to +200°C
- DPDT
- Non-latching
- Latching
- Sensitive non-latch
- 412H, 422H, 432H



422H

HIGH SHOCK

- Shock up to 4,000 g's
- -65°C to +125°C
- DPDT
- Latching & Non-latch
- 412K, 422K



412K

HIGH VIBRATION

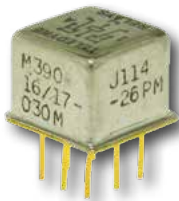
- Vibration up to 380 g's
- 10M Life Cycle
- DPDT, non-latching
- Internal Diode option
- 412V, 412DV



412DV

MILITARY GRADE JAN RELAYS

QPL Qualified Parts



J114

- MIL-PRF-39016
- MIL-PRF-28776
- SPDT, DPDT
- Latching & Non-latch
- TO-5, .100 Centigrd
- CMOS Transistor Driver
- TVS & Polarity Diodes



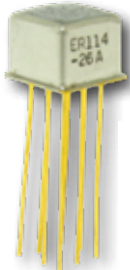
J412D

- DPDT 1/2 Crystal Can
- Resistive: 2A/28Vdc
- MIL-PRF-39016/45 Qualified
- Hermetically Sealed
- 1 Million Cycle Life

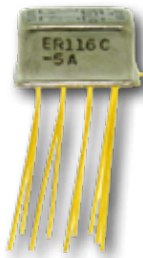


J255

ESTABLISHED RELIABILITY RELAYS



ER114



ER116C

- A & B Level Screening
- More Spacer/spreader pad options
- Added Ground Pin Option
- Reduced Cost
- Reduced Leadtime



ER420



ER432

EMR SCREENING LEVELS

INSPECTION	Screening Levels			
	A Level 1.5%/10K Cycles	B Level .75%/10K Cycles	JAN L Level 3%/10K Cycles	JAN M Level 1%/10K Cycles
Subgroup 1				
Screening, Internal Moisture AQL ¹	✓	✓	✓	✓
Vibration (Sinusoidal) AQL ¹			✓	
Vibration (Sinusoidal) 100%		✓		✓
Screening, Burn-In (Hybrids only)			✓	✓
Screening, Run-In (Room Temperature)	✓			
Screening, Run-In (+125°C and -65°C)		✓	✓	✓
Subgroup 2				
Coil Resistance or Coil Current	✓	✓	✓	✓
Insulation Resistance	✓	✓	✓	✓
Dielectric Withstanding Voltage	✓	✓	✓	✓
Static Contact Resistance	✓	✓	✓	✓
Pickup and Dropout or Set and Reset Voltage	✓	✓	✓	✓
Operate and Release or Set and Reset Time	✓	✓	✓	✓
Hold Voltage			✓	✓
Turn-On and Turn-Off Time (Hybrids only)	✓	✓	✓	✓
Contact Bounce Time	✓		✓	
Contact Stabilization Time		✓		✓
Turn-On Current (T Hybrids only)	✓	✓	✓	✓
Turn-On Voltage (C Hybrids only)	✓	✓	✓	✓
Turn-Off Voltage (Hybrids only)	✓	✓	✓	✓
Coil Transient Suppression (D, DD and Hybrids only)	✓	✓	✓	✓
Diode Blocking Integrity (DD only)	✓	✓	✓	✓
Zener Voltage (C Hybrid only)	✓	✓	✓	✓
Neutral Screen (Latching Relays only)	✓	✓	✓	✓
Break Before Make Verification			✓	✓
Contact Simultaneity			✓	✓
Subgroup 3				
Solderability 2 Samples per Daily Solderability Inspection Lot	✓	✓	✓	✓
Leak Test	✓	✓	✓	✓
External Visual and Mechanical Inspection 2/Lot for Dimension and Weight Check	✓	✓	✓	✓



SPDT SWITCHES



CR-50U
DC-53GHz

- Operating Frequency from **DC - 67GHz**
- Excellent Insertion Loss Repeatability
- Characterized at 5 million cycles
- Compact design with high performance



CCR-33S
DC-18GHz



CCR-40K
DC-40GHz



CCR-67V
DC-67GHz



CRT-33S
DC-22GHz



CCS-32N
DC-12GHz



CCR-53S
DC-26.5GHz

OPTIONS

- Failsafe or Latching
- Internal 50 Ω Termination
- 12, 15, 24, or 28Vdc Actuation
- SMA, TNC, N, 2.92mm & 2.4mm
- Indicators, Self Cutoff (Latching Only)
- TTL, Diodes, Moisture Seal, D-Sub

MULTI-THROW SWITCHES

- DC - 52GHz
- Internal 50 Ω Termination
- SMA, 2.92mm, TNC, N, & U
- SP3T - SP12T
- 5 Million Cycles
- Normally Open & Latching



CR-39U
DC-52GHz



CCT-58S SP12T
DC-18GHz



CCS-18
DC-12GHz



CCR-39S SP10T
DC-18GHz



CCR-58S
DC-26.5GHz



CCR-48K
DC-40GHz

TRANSFER & 2P3T SWITCHES



CR-37U
DC-52GHz

- Operating Frequency from **DC - 52GHz**
- SMA, 2.92mm, TNC, N, & U
- 5 Million Cycles
- High Power N & TNC
- Failsafe & Latching



CCS-47N
DC-12GHz



CCS-37K
DC-40GHz

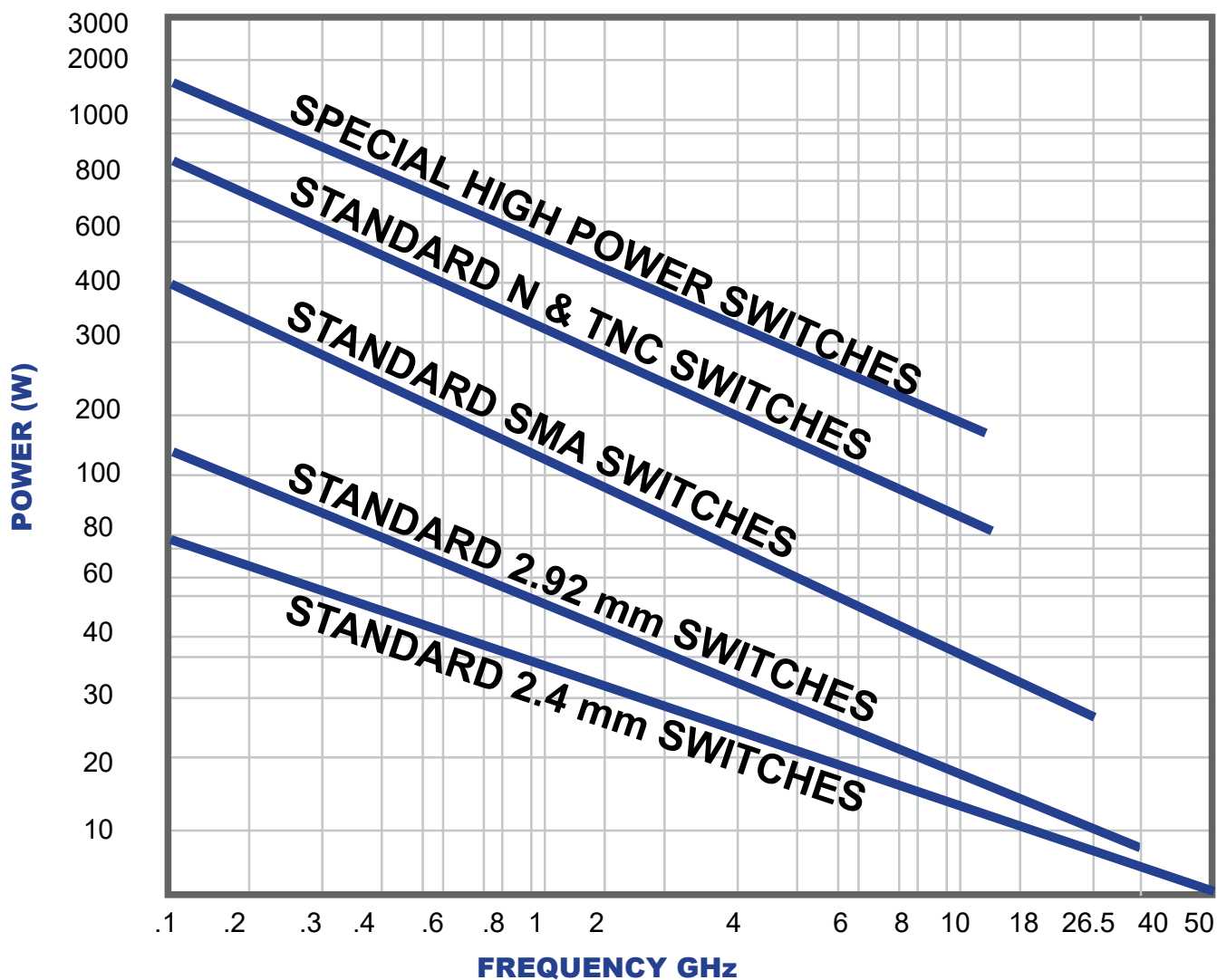


CCRS-33S
DC-18GHz



CCS-37S
DC-26.5GHz

POWER VS FREQUENCY



MATRIX



Teledyne, the world's innovative leader in manufacturing electromechanical and solid-state switching products for more than 50 years, offers a modular approach to matrix

assembly switching. Incorporating highly repeatable and long-cycle-life relays and switches, Teledyne's matrices cover the spectrum from DC to 67GHz. Teledyne's modular approach to building matrices allows assembly of a vast array of customized matrix assemblies with the same standard sub-assemblies. The internal components of the assembly and main module utilize Teledyne's proven relays



and switches. Teledyne has developed a standard programmable microcontroller that can be used for nearly any matrix configuration. The universal power supply allows the matrix assembly to be used worldwide. Teledyne is highly vertically integrated, which reduces development time, qualification time, cost and lead time, while ensuring high quality and cost-effective production.



To learn more, call us or visit us online today. And see what Teledyne Coaxial Switches can do for you.

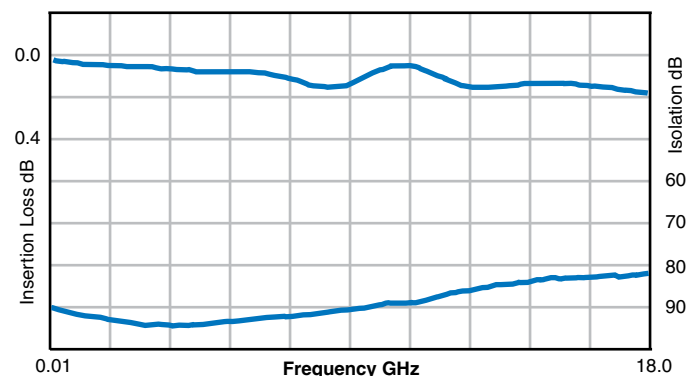


FEATURES

- Fully customized switching configurations
- Universal Power Supply
- Visual Display – LED
- Standard and custom racks available
- Manual/direct and/or remote control
- Multiple interface configurations:
 - RF ports – SMA, 2.92mm, 2.4mm, N, SMB, TNC, etc.
 - Control – RS-232, Ethernet, USB, Keypad, etc.
- 50 and 75 ohm impedances



TYPICAL INSERTION LOSS / ISOLATION**





CUSTOM SWITCH MATRIX



ADDITIONAL FEATURES

- Monitor cycle count
- System health/system status
- LEDs: Visual status
- In-circuit programming

EXTERNAL KEYPAD



System Display
Multi-Character LED

Universal Controller

Power Supply

Remote Interface

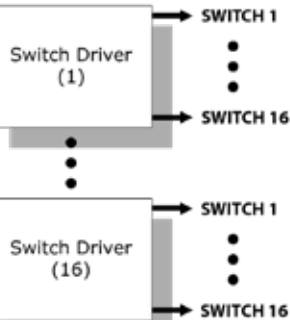
USB

GPIB

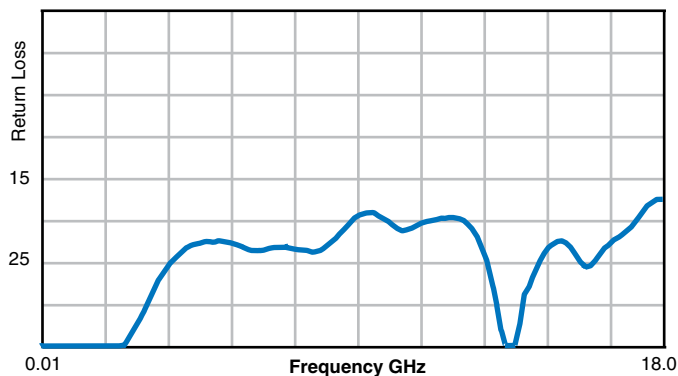
Ethernet
TCP/IP

RS-232

Parallel TTL



TYPICAL RETURN LOSS**



**Sample measurement from a 1x40 switch matrix.
For reference only, contact factory for additional details

Mini Matrix



The MMA, MMB & MMC series are an ideal solution that incorporate Teledyne Coax Switches with remote control via USB and/or TCP/IP (Ethernet). Remote operation is accomplished via Windows GUI or ASCII (command set provided).



TYPICAL RF CHARACTERISTICS

Frequency	DC-6 GHz	6-12 GHz	12-18 GHz	18-26.5 GHz	26.5-34 GHz	34-40 GHz	40-52 GHz
Insertion Loss	0.20 dB	0.40 dB	0.50 dB	0.90 dB	1.00 dB	1.20 dB	1.40 dB
Isolation	80 dB	80 dB	80 dB	70 dB	65 dB	60 dB	60 dB
VSWR	1.25:1	1.40:1	1.50:1	1.60:1	1.70:1	1.80:1	2.00:1



Mini Matrix
App Form!



- Off the Shelf design
- Open Port (Labview & C++ Compatible)
- Controller supports 2 x 8 output channels @ 24V
- Discrete control
- Controlled through USB/Ethernet
- Windows GUI & API provided

CONFIGURATIONS AVAILABLE

Series	Frequency	Connector Type	Quantity	Cycle Life
SPDT	18, 26.5, 40, 53, 67 GHz	SMA, 2.92mm	Up to 4 SPDT	5M Cycles
Transfer	18, 26.5 GHz	SMA, 2.92mm	Up to 4 Transfer	5M Cycles
Multi-Throw	18, 26.5, 40, 53 GHz	SMA, 2.92mm	Up to 2 SP8T	5M Cycles

Airworthy Custom Matrix Boxes



TELEDYNE
COAX SWITCHES
Everywhereyoulook™





For over fifty years Teledyne Relays has been supplying high reliability switching solutions intended for space flight applications. As the inventor of the ultra-miniature T0-5 electromechanical relay Teledyne Relays has been involved with all facets of the modern space age. From the earliest NASA missions Teledyne Relays has supplied T0-5 relays and RF Coax Switches for use in all type of space craft: manned, unmanned, deep space and robotic exploration.



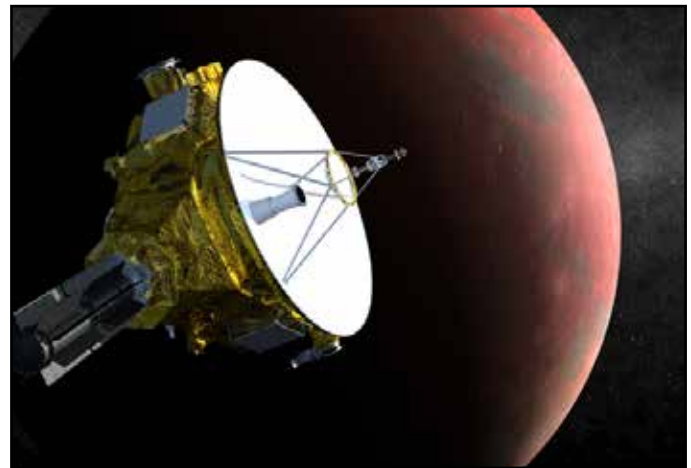
Ariane V Launch Vehicle

Space Market Segments Served:

- Deep-space Probes
- Manned Programs
- Communications Satellites
- Launch Vehicles
- Earth Observatory / Weather Satellites
- Commercial/Military Satellites

Capabilities:

- Logistic Infrastructure
- Chemical Analysis Lab
- Scanning Electro Microscope (SEM)
- In-house Plating Shop
- Environmental Test Lab
- Field Technical Support



New Horizons Spacecraft

SPACE STANDARDS



Specifications

- NASA/GSFC S-311-P-754
- NASA EEE-INST-002
- ESA/SCC 3601
- ESA/SCC 3602
- TR-HIREL-1

Certifications

- MIL-PRF-39016
- MIL-PRF-28776
- MIL-STD-790
- BOEING D1-9000
- ISO 9001:2008
- NASA/JEDEC Solder Requirements

Required Tests

- 100% Pre-Cap
- Small Particle Inspection (Millipore Inspection)
- Sinusoidal Vibration
- Resonant Beam Test
- P.I.N.D. Test
- Internal Moisture
- Temperature Condition, High and Low Temperature Miss Test
- Electrical Measurements
- Leak Test
- Radiographic Inspection (X-Ray)
- Visual Inspection

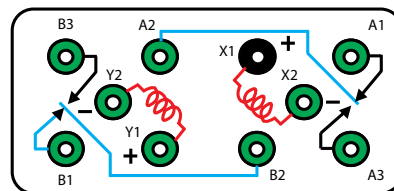


ELECTROMECHANICAL RELAYS

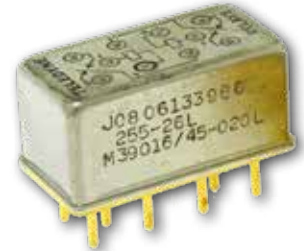
Contact Load and Life Ratings

LOAD LEVEL	CONTACT LOAD
Low level/Mechanical	10-50µA at 10-50 mVdc or Peak AC
Intermediate Current	100mA at 28Vdc
High Level, Resistive	2.0A at 28Vdc
High Level, Inductive	750 mA at 28Vdc, with 0.20H inductance
High Level, Lamp	160mA at 28Vdc
Overload, Resistive	4.0A at 28Vdc

Form Factor	2 Form C (DPDT)	Operating Temperature	-65°C to +125°C
Frequency Range	DC-3 GHz	Vibration (Sinusoidal)	30 g's 10 to 2500 Hz
Lead Finish	Gold Plated or Solder Coated	Shock (Specific Pulse)	100 g's, 6ms half sine
Hermetic Seal	1 x 10 ⁻⁸ atm-cm ³ /s	Weight	0.10 oz. (2.84) max.



HR255 SHECMATIC



HR255



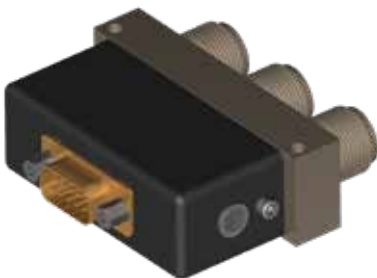
HR422 / HRS422



HR412 / HRS412

Form Factor	2 Form C (DPDT)	Operating Temperature	-65°C to +125°C
Frequency Range	DC-3 GHz	Vibration (Sinusoidal)	30 g's 10 to 2500 Hz
Lead Finish	Gold Plated or Solder Coated	Shock (Specific Pulse)	100 g's, 6ms half sine
Hermetic Seal	1 x 10 ⁻⁶ atm-cm ³ /s	Weight	0.10 oz. (2.84) max.

COAXIAL SPDT SWITCH



H-32N

Form Factor	SPDT, break before make
Frequency Range	L, S, C, X
RF Leakage	-95 dBc, 10dBm, @300 MHz
Characteristic Impedance	50 Ohms
Operating Temperature	-55°C to +85°C
Vibration, 10 ~ 2000 Hz, 300 s (MIL-STD-202 Method 214, Condition C)	10 G peak
Shock, Half-Sine Pulse (MIL-STD-202 Method 213, Condition D)	500 G peak

PERFORMANCE CHARACTERISTICS				
Frequency Option	F2 (L-BAND) DC-2 GHz	F4 (S-BAND) 2-4 GHz	F8 (C-BAND) 4-8 GHz	F12 (X-BAND) 8-12 GHz
Insertion Loss (max)	0.2 dB	0.3 dB	0.4 dB	0.55 dB
Isolation (min)	70 dB	70 dB	70 dB	60 dB
VSWR (max)	1.2:1	1.3:1	1.3:1	1.6:1

SPACE



H-33S

Form Factor	SPDT, break before make
Frequency Range	L, S, C, X, KU, K
RF Leakage	-95 dBc @ 300 MHz
Characteristic Impedance	50 Ohms
Operating Temperature	-55°C to +85°C
Vibration, 10 ~ 2000 Hz, 300 s MIL-STD-202 Method 214, Condition C	10 G peak
Shock, Half-Sine Pulse MIL-STD-202 Method 213, Condition D	500 G peak

PERFORMANCE CHARACTERISTICS						
Frequency Option	F2 (L-BAND) DC-2 GHz	F4 (S-BAND) 2-4 GHz	F8 (C-BAND) 4-8 GHz	F12 (X-BAND) 8-12 GHz	F18 (KU-BAND) 12-18 GHz	F26 (K-BAND) 18-26 GHz
Insertion Loss (max)	0.15 dB	0.25 dB	0.35 dB	0.35 dB	0.40 dB	0.65 dB
Isolation (min)	80 dB	70 dB	70 dB	70 dB	60 dB	55 dB
VSWR (max)	1.5:1	1.25:1	1.30:1	1.35:1	1.40:1	1.65:1

TRANSFER SWITCH



H-47N

PERFORMANCE CHARACTERISTICS				
Frequency Option	F2 (L-BAND) DC-2 GHz	F4 (S-BAND) 2-4 GHz	F8 (C-BAND) 4-8 GHz	F12 (X-BAND) 8-12 GHz
Insertion Loss (max)	0.2 dB	0.3 dB	0.4 dB	0.6 dB
Isolation (min)	70 dB	70 dB	60 dB	60 dB
VSWR (max)	1.20:1	1.30:1	1.40:1	1.65:1

Form Factor	Transfer, break before make
Frequency Range H-37N H-37S	L, S, C, X L, S, C, X, KU, K
RF Leakage H-37N H-37S	-95 dBc, 10dBm, @300 MHz -95 dBc @ 300 MHz
Characteristic Impedance	50 Ohms
Operating Temperature	-55°C to +85°C
Vibration, 10 ~ 2000 Hz, 300 s MIL-STD-202 Method 214, Condition C	10 G peak
Shock, Half-Sine Pulse MIL-STD-202 Method 213, Condition D	500 G peak



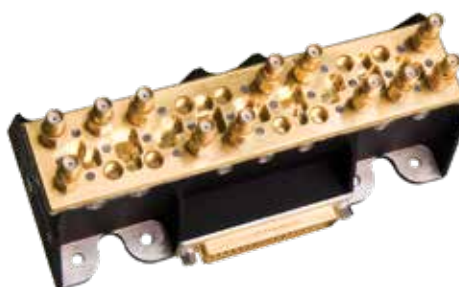
H-37S

PERFORMANCE CHARACTERISTICS					
Frequency Option	F2 (L-BAND) DC-2 GHz	F4 (S-BAND) 2-4 GHz	F8 (C-BAND) 4-8 GHz	F12 (X-BAND) 8-12 GHz	F18 (KU-BAND) 12-18 GHz
Insertion Loss (max)	0.15 dB	0.25 dB	0.35 dB	0.50 dB	0.65 dB
Isolation (min)	80 dB	70 dB	70 dB	70 dB	60 dB
VSWR (max)	1.15:1	1.30:1	1.35:1	1.40:1	1.60:1

SWITCH BLOCK

What is a switch block?

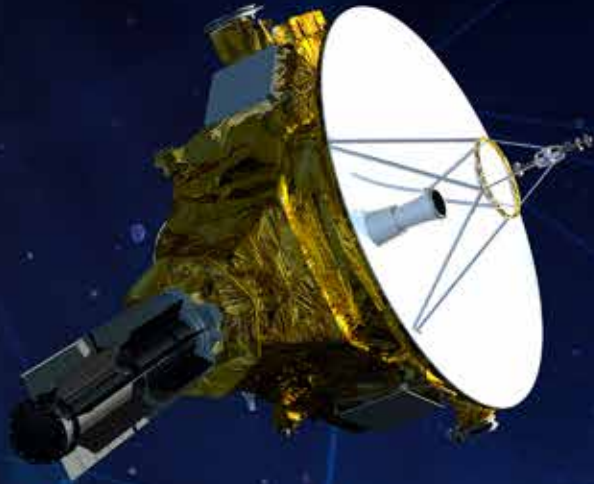
A switch block is a system composed of multiple individual space qualified switches connected to achieve multi-input and multi-output configurations, allowing you to reduce space. A switch block can consist of SPDT and Transfer switches to achieve customized switching configurations.



Teledyne Switch Blocks Feature:

- D-Connectors
- Custom Mounting
- Venting (Pressure Control)
- Custom switching patterns
- Transient Suppression (Diode Protection)
- Custom Telemetry Interfaces/Connections

Switching Solutions for Diverse Industries



TELEDYNE
RELAYS
Everywhere you look™



TELEDYNE
COAX SWITCHES
Everywhere you look™



INDUSTRIAL SOLID STATE RELAYS (AC)



SH Series
Single Phase AC
Output to 125A, 690Vac
SSR w/ Touch-proof Flaps



S Series
Single Phase AC
Up to 125A, 660Vac
Hockey Puck SSR



DH Series
Single Phase AC
Up to 50A, 600Vac SSR



SD Series
Up to 50A 600Vac Hockey
Puck Dual SSR



FS Series
Single Phase AC
Up to 20A, 280Vac
Miniature SSR



L Series
Single Phase AC
25A, 280Vac Ultraminiature SSR



BS Series
Single Phase AC
4A, 600Vac SIP



E3P2G Series
Three Phase SSR
Up to 75A, 600Vac



SQ Series
Quad Output SSR
25A, 280Vac each



TS Series
Single Phase AC
2A, 275Vac PCB SSR

		CURRENT									
		≤ 125A									
		≤ 95A									
		≤ 75A									
		≤ 50A									
		≤ 35A									
		≤ 25A									
		≤ 12A									
		≤ 9A									
		≤ 4A									
AC	LINE VOLTAGE	240Vac (≤ 280Vac)	AS4			SH	SH	SH	SH	SH	SH
			BS		STH	STH	STH	STH			
					S	S	DRS	SHP			
					ST	ST					
								SD			
					FS	FS					
						DH					
						L					
						LS					
						C3P					
						SQ					
			480Vac (≤ 520Vac)	AS4		G	DR3P	SH	SH	SH	SH
				S3P							
					S		S	S	S	S	
						DH					
							SD				
						XV	E3P2G	E3P2G			
							E3PT				
				E3PT							
	600Vac (≤ 690Vac)	AS4			LS	LS	SH	SH	SH	SH	
		BS				STH	STH	STH			
							S	S	S	S	
				ST	ST		ST	ST			
							SD				
							E3PT	SD			
				E3P2G	E3P2G		E3P2G	E3P2G			

INDUSTRIAL SOLID STATE RELAYS (DC)

		CURRENT									
		≤ 150A									
		≤ 125A									
		≤ 95A									
		≤ 75A									
		≤ 50A									
		≤ 35A									
		≤ 25A									
		≤ 12A									
		≤ 9A									
		≤ 4A									
DC	Voltage	≤ 36Vdc			LS10						
		≤ 60Vdc	DX					SHDC			S75
			DS								
		≤ 130Vdc					S20	SHDC			S20
		≤ 220Vdc	DX								
			DS								
		≤ 350Vdc						S60			SI



SI Series
DC SSR
Output up to 100A, 500Vdc



S60DC40 Series
DC SSR w/ status LED
Output 40A, 350Vdc



DX Series
Up to 3A, 60Vdc
DIN Rail SSR
Optional LED



LS10 Series
DC SSR
10A, 60Vdc PCB mount



S75DC150 Series
DC SSR w/ status LED
Output 150A, 42Vdc



SHDC Series
Output up to 40A, 100Vdc
Over-voltage protection
IP20 touch-proof flaps

MOTOR CONTROLLERS



EMCRT Series

Part Number	Motor Current	Main Voltage	Peak Voltage	Switch Type	Control Voltage	I ² T
EMCRT48D50	8.5A	24-520 Vac	1600 Vpk	Zero Cross	12-30 Vdc	1500A ² S
EMCRT48D75	16A	24-550 Vac	1600 Vpk	Zero Cross	12-30 Vdc	5000A ² S

- Up to 10hp motors
- Controls and reverses 3-Phase motors without direct third leg (two legs)
- IP20 touch-proof housing
- Built-in snubber and MOV
- Very high immunity components, 1600Vpeak
- Forward/Reverse display LED

- Reduce high in-rush currents
- Reduce mechanical stress on load
- Heat Sink and Fan integrated
- Diagnostic feedback
- Soft-Start Motor Controller, designed for up to 25kW motors



EMCRT Series

Max. Motor Power @40°C				IAC53a @40°C		Phase to Phase Voltage	Mains Frequency	Input	Status Output	In/Out/ Case Isolation	Operating Temp
Star (Y)		Delta (D)		Max.	EN60947- 4-2						
400Vac	230Vac	400Vac	230Vac								
15kW	8.6kW	26kW	15kW	30A	22.5A	200 to 480Vac	40 to 65Hz	10 to 24Vdc	24V/1A AC/DC	4kV	−40°C to +100°C

Military Solid-State Relays; for applications where more robust and highly qualified parts are required. Teledyne Relays offers high-performance products designed to comply with MIL-PRF-28750.



SILICON CARBIDE TECHNOLOGY



LD00KM
10A, 270Vdc Load
4.2-32Vdc Control

- Meets MIL-STD-704
- Tested Per MIL-PRF-28750
- Low ON resistance
- Low Profile
- Hermetic Package
- Silicon Carbide MOSFET

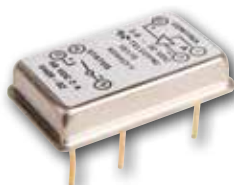


LD24KK
5A, 270Vdc Load
4.2-16Vdc Control
Short Circuit Protection & Trip Status



LD00KQ
20A, 270Vdc Load
4.2-18Vdc Control

DC SOLID STATE RELAYS



KD44CF
2A, 60Vdc Load
Direct, TTL or CMOS control

- Screened to MIL-PRF-28750
- Chassis & PCB Mount
- Short-Circuit Protection
- Optical & Transformer Isolation
- Plastic & Hermetically Sealed

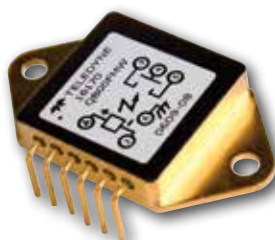


SR75-1ST
1.5A, 60Vdc Load
Surface Mount



M33-2NW
7A, 60Vdc Load
Up to 100 Amp pulse load

BI-DIRECTIONAL / AC SOLID STATE RELAYS



QB00FM
7.5A, 150Vdc Load
 $\pm 4.3A, \pm 150Vac$ Load



C46F Series
Bi-directional

- Meets MIL-PRF-28750
- Tested Per MIL-STD-704
- Up to 250Vac, 25A
- Chassis & PCB Mount
- Short-Circuit Protection
- Plastic & Hermetically Sealed



652
25A, 250Vrms Load
Zero-Cross

MILITARY QUALIFIED SOLID STATE RELAYS



CD20CDY
DESC# 90091-004

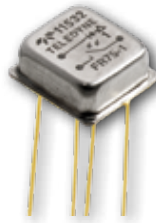
List of QPL & DESC
Qualified Part Numbers



HD22CFY
DESC# 88062-002

COMMERCIAL

- Up to 250Vac, 10A
- Short-Circuit Protection
- Chassis and PCB Mount
- Zero-Cross & Random Switching
- Low Off-State Leakage Current



FR75-1



LPBD100



C60

SCREENING LEVELS

Inspection	S ² R Level "W"	S ² R Level "T"	MIL-PRF-28750 Level "Y"
Destructive Wirebond Pull Test (Sample test) MIL-STD-883 Method 2011	✓	✓	✓
Internal Visual MIL-STD-883 Method 2017	✓	✓	✓
Constant Acceleration MIL-STD-883 Method 2001, 5000 Gs, Y1 axis			✓
Temperature Cycling MIL-STD-883 Method 1010, 10 cycles	✓ Specified temp range	✓ Specified temp range	✓ -55° to +125°C
Load Conditioning 3 hours at rated input and load 90% duty cycle, 1 to 30 operations per second (latching fault indication for drop out)	✓	✓	✓
Pre Burn-In (optional)			✓
Burn-in Test MIL-STD-883 Method 1015, 160 hours at specified temperature and rated load (latching fault indication on failure)		✓ (48 hours of same testing for plastic- packaged relays)	✓
Dielectric Withstanding Voltage MIL-STD-202 Method 301	✓	✓	✓
Insulation Resistance MIL-STD-883 Method 1003	✓	✓	✓
Electrical Characteristics at -55°C		✓	✓
Electrical Characteristics at +25°C	✓	✓	✓
Electrical Characteristics at +125°C (or as specified)		✓	✓
Seal MIL-STD-202 Method 112 (Gross) MIL-STD-883 Method 1014 (Fine)	✓ (N/A for plastic- packaged relays)	✓ (N/A for plastic- packaged relays)	✓
Visual/Mechanical (Sample test)	✓	✓	✓
Solderability (2 Samples) MIL-STD-202 Method 208		✓	✓



Active RF Switches

DESCRIPTION

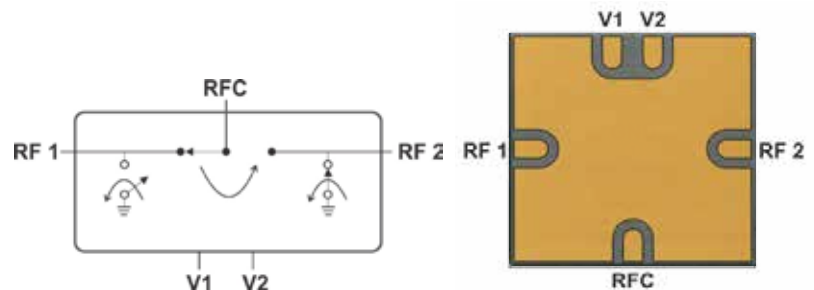
The InP1012-60 is a highly compact, reflective SPDT Active RF switch, manufactured using Teledyne's high-speed, low-loss InP HEMT process. The switch die is packaged in a low-loss, surface mount package, with a small form factor: 3mm (L) × 3mm (W) × 1mm (H). It supports a wide frequency range from DC to 60 GHz, and delivers low insertion loss, fast switching time, and good isolation—making this switch ideal for test and measurement, microwave communications, and radar applications. The InP1012-60 can also tolerate up to 100krads of radiation, allowing it to be used in space applications.

The following unique construction features and manufacturing techniques provide excellent robustness to environmental extremes and overall high reliability:

- Monolithic solid-state switch with no mechanical wear
- Flip-chip packaging provides shock & vibration resistance
- ENEPIG surface finish for solder bonding
- Low loss package with organic overmold
- Test board with K-connector can be provided

The InP1012-60 features:

- High digital bandwidth, greater than 40 Gbps
- Broad frequency bandwidth, DC - 60 GHz
- Small form factor, 3mm X 3mm X 1mm
- Low insertion loss
- Very High linearity
- Wide operating temperature
- Radiation tolerant up to 100krads
- Very fast switching time of less than 100ns



ENVIRONMENTAL AND PHYSICAL SPECIFICATIONS

Temperature (Ambient)	Storage	-65°C to +125°C
	Operating	-65°C to +125°C
Enclosure		Low-Loss Surface Mount Package
ESD Sensitivity (HBM)		Class 1
MSL Sensitivity		TBD
Radiation Tolerance		100krads

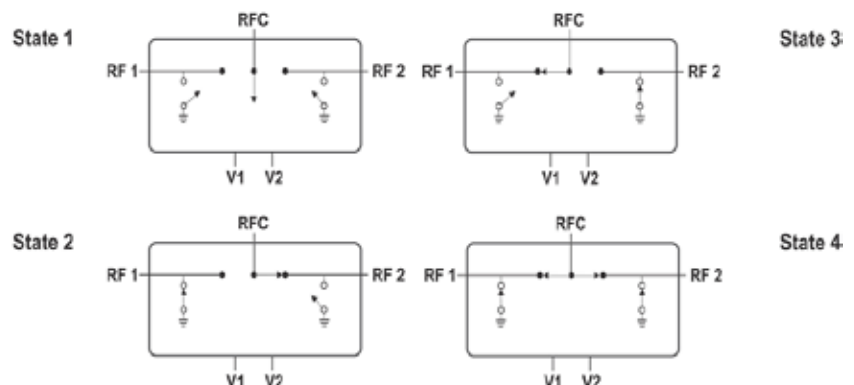
RECOMMENDED OPERATING CONDITIONS

Parameter	MIN	TYP.	MAX	UNIT
Control ON (V1,V2)	-0.3	0	+0.3	V
Control OFF (V1,V2)	-2.0	-2.5	-3.0	V
Control Current		200	700	μA

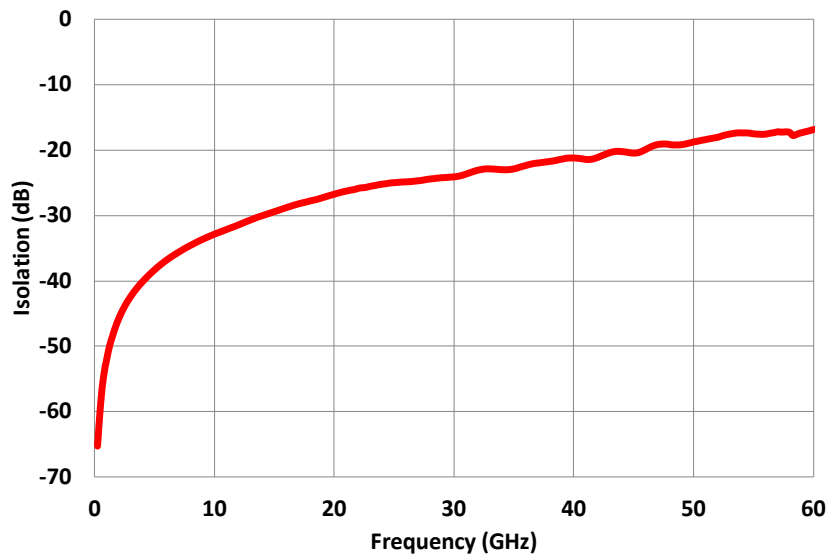
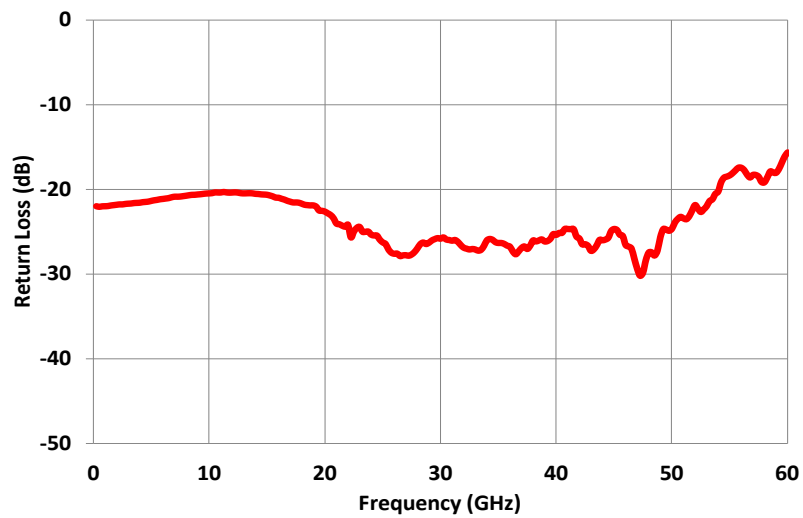
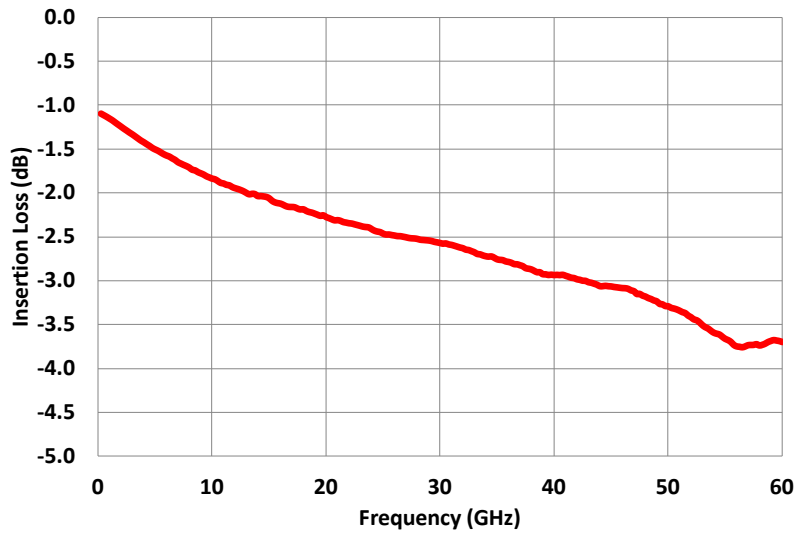
SWITCH STATES

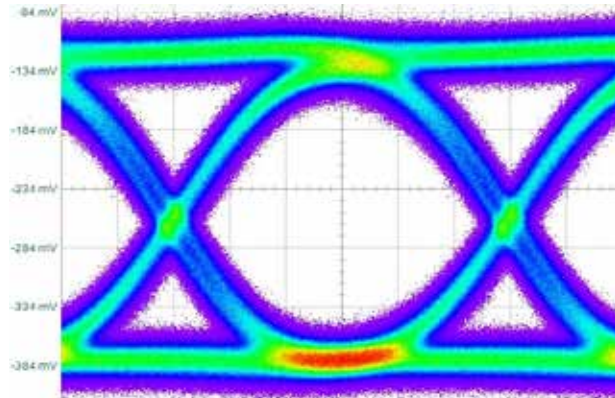
V1	V2	RF1	RF2	STATE
-2.5V	-2.5V	OFF	OFF	1
-2.5V	0V	OFF	ON	2
0V	-2.5V	ON	OFF	3
0V	0V	ON	ON	4

Note: Operation between -0.3V and -2.0V is not recommended.

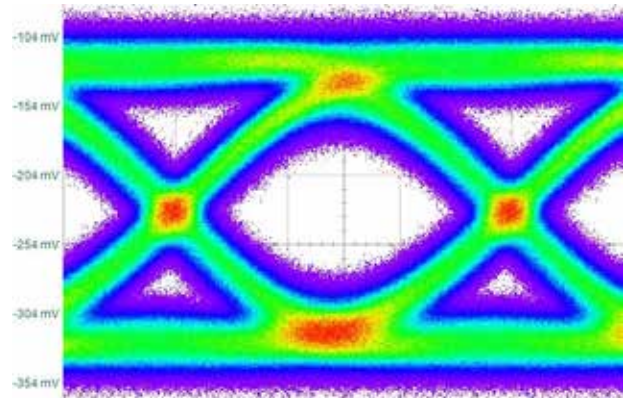


Insertion Loss and Isolation Plots

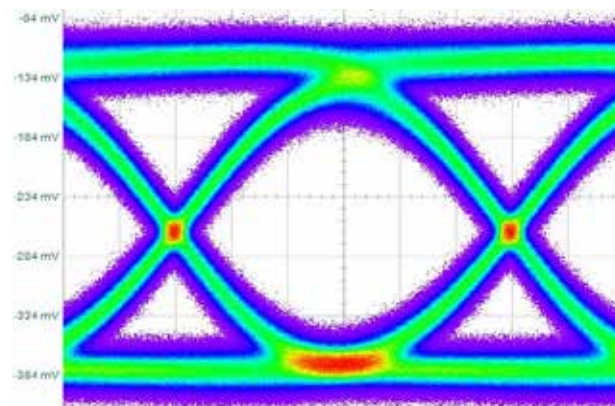




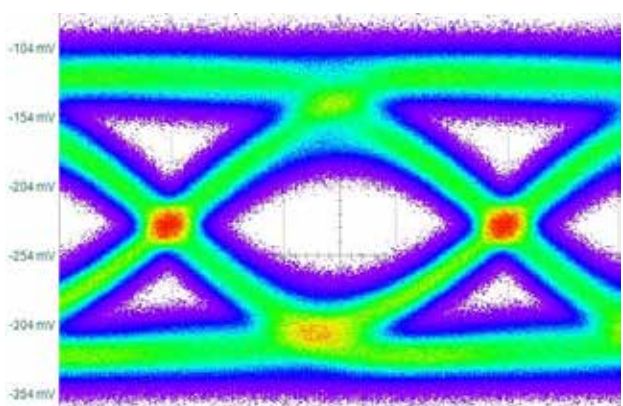
Reference @ 40 Gbps



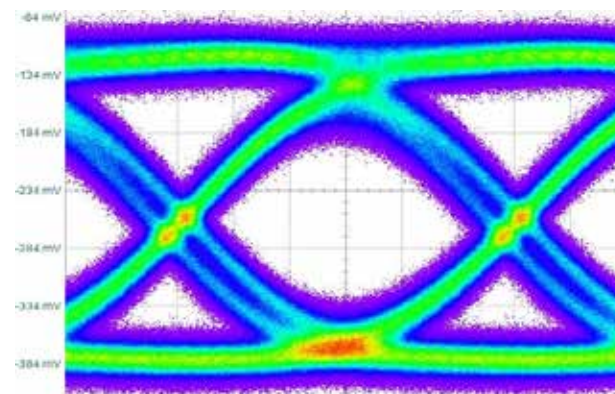
InP1012-60 @ 40 Gbps



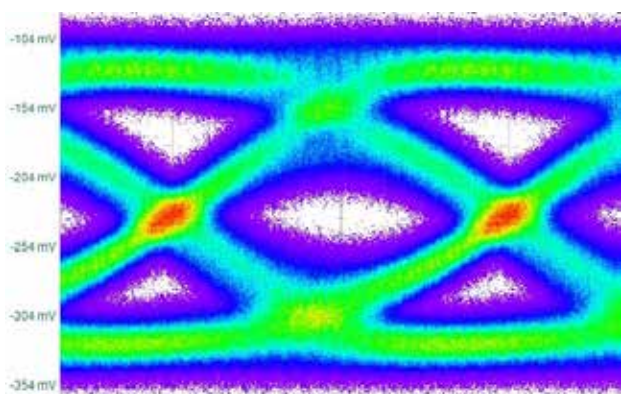
Reference @ 48 Gbps



InP1012-60 @ 48 Gbps



Reference @ 56 Gbps



InP1012-60 @ 56 Gbps

MEASUREMENTS NOTES

DUT measurements were made using an oscilloscope.
The relay was mounted on an evaluation board.

Pattern Generator Settings

- $2^{31}-1$ PRBS signal
- 40Gbps data rate
- Data amplitude of 500mVpp

Electrical Specifications

GENERAL ELECTRICAL SPECIFICATIONS (@25°C)

Contact Arrangement	1 Form C (SPDT)
Rated Duty	Continuous
Operating Power	1-2 mW
Switching Time	60-100 ns

TYPICAL ELECTRICAL SPECIFICATIONS

(@25°C, V1 = ON, V2 = OFF OR V1 = OFF, V2 = ON, $Z_s = Z_L = 50 \Omega$)

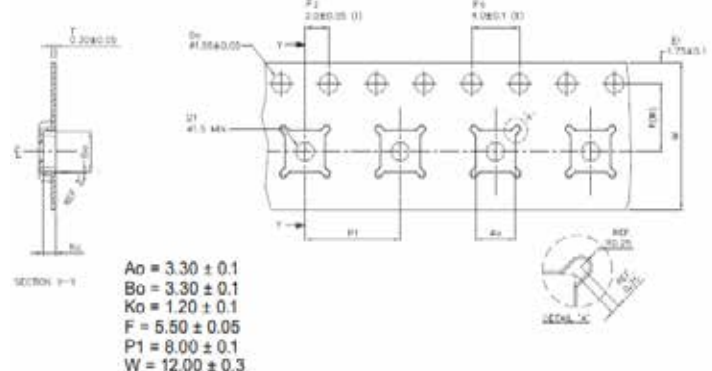
OPERATING FREQUENCY: DC - 60GHz

Parameter/Condition	Path	Condition	Typical	Unit
Insertion Loss	RFC-RFX	DC (20mV - 200mV) *	2.0	dB
		10 kHz	0.9	dB
		100 MHz	1.2	dB
		6 GHz	1.6	dB
		14 GHz	2.0	dB
		20 GHz	2.3	dB
		30 GHz	2.6	dB
		40 GHz	2.9	dB
		50 GHz	3.3	dB
		60 GHz	3.7	dB
Isolation	RFC-RFX	10 kHz	67	dB
		100 MHz	60	dB
		6 GHz	37	dB
		14 GHz	30	dB
		20 GHz	27	dB
		30 GHz	24	dB
		40 GHz	21	dB
		50 GHz	19	dB
		60 GHz	17	dB
Isolation	RF1-RF2	100 MHz	69	dB
		100 MHz - 26.5 GHz	32	dB
		26.5-40 GHz	27	dB
		45- 60 GHz	17	dB
Return Loss (active port)	RFC-RFX	100 MHz	23	dB
		6 GHz	21	dB
		14 GHz	21	dB
		20 GHz	23	dB
		30 GHz	26	dB
		40 GHz	25	dB
		50 GHz	25	dB
		60 GHz	16	dB
Input 0.1dB compression point		100 MHz	3.1	dBm
		6 GHz	15.7	dBm
		18 GHz	14.9	dBm
Input 1dB compression point		100 MHz	8.6	dBm
		6 GHz	21.1	dBm
		18 GHz	21.8	dBm
Input 3 rd Order Intercept (IIP3)		10GHz	37.5	dBm

DIE INFORMATION

PARAMETER	MIN	TYP	MAX	UNIT
Die Size, Singulated (x,y)	820 x 950	830 x 960	840 x 970	μm
Wafer Thickness	615	625	635	μm
Bump Pitch	150			μm
Bump Height	50	60	70	μm
Bump Diameter		79		μm
UBM Diameter	65	69	74	μm

TAPE AND REEL PACKAGING





HYBRID SOLUTIONS

Experienced in Custom Hybrid Solutions

Teledyne Relays is a leading manufacturer with the capability of providing build-to-print solutions on hybrid microcircuits devices. Our current product portfolio includes solid state power controllers, DC-DC converters, high current drivers, digital-analog converters, activator control hybrids, deflection amplifiers, base drivers, custom designed multi-layers thick-film/thin film substrates and many more...

With over 50 years of heritage in serving the space, aerospace and defense markets, Teledyne continues to uphold the same standards and commitment to excellence. Our optimized solutions are supported by teams of engineers and manufacturing personnel with wide ranging experience in developing products deployed in highly demanding applications, such as electrical power systems, radar receivers, and stores management solutions for ground or aerial defense platforms.

Teledyne is accredited by Defense Logistics Agency (DLA) in accordance with MIL-PRF-38534, Class H and Class G Qualified Manufacturers List (QML). Since 2014 Teledyne has successfully launched over twenty hybrids into production for our customers. We welcome opportunities to partner with our customers to provide customized solutions to your hybrid needs. Our typical custom solution development cycle is as follows:



Submit an Inquiry Here!



HYBRID MICROCIRCUITS

General Hybrid Assembly

While there are different approaches in hybrid manufacturing, a standard hybrid involves the integration of active and passive chips into a substrate using eutectic and/or epoxy attach processes, substrate attachment to metal enclosure, clean, wire bonding, trim (as required) and test, and hermetic sealing. In essence chip-and-wire is the core technology of hybrid assembly utilizing different tightly controlled and repeatable processes to assemble products with precision, consistency and reliability. Such products will be subjected to the environmental stress screening (ESS) testing in accordance with the MIL-PRF-38534 unless otherwise specified by special customer requirements.

Hybrid Microcircuits vs Printed Circuit Assembly

There are substantial advantages in using hybrid microcircuits when compared to printed circuit assembly (PCA):

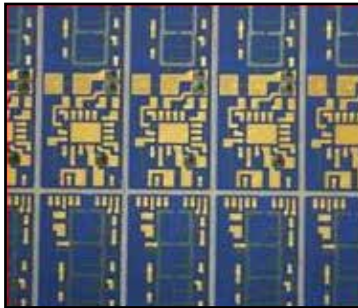
- **Miniaturization** - Hybrids utilize unpackaged dies which are significantly lower in size and weight than the packaged devices used on PCA. Although they may not be more economical to produce than PCA, when the mass of PCA are considered in the overall cost, hybrids become comparable in application where size and weight matters.
- **Hermetic Protection** - Hybrids are microcircuits contained within a hermetically sealed and corrosion resistance enclosure. All components are protected from moisture ingress or other adverse environmental changes.
- **Wider Operating Temperature Range** – Since materials used in hybrid microcircuits generally are capable of handling higher temperature than PCA materials can, hybrid microcircuits are designed into critical applications where wider temperature ranges are needed.
- **Better Thermal Management** – Commonly used PCB materials inherently have poor thermal conductivity creating hotspots which may affect life of the components mounted nearby. Hybrids use higher thermally conductive Alumina, Aluminum Nitride or Beryllium Oxide (BeO) substrates to help dissipate heat more uniformly over the surface and increase components lifespan in general.
- **Higher Reliability** – Hybrids use significantly fewer solder joints than PCA, which increase the fundamental reliability of the circuits. Since it is hermetically sealed, circuit interconnections are contained within the hybrid, thus shielded from the adverse influence of the environment in which the application may be exposed.
- **Recognized Qualification** – When required, hybrid microcircuits may be qualified in accordance with MIL-PRF-38534 as a standalone item for Class G, Class H or Class K, as applicable, to demonstrate performance and reliability of such design. Standard hybrids are subjected to burn-in and MIL-PRF-38534 Group A screening requirements to assure high quality is maintained.

Teledyne Relays has developed extensive experience and strong capabilities in the following areas:

THICK & THIN FILM SUBSTRATES

Thin Film Substrates

- Ti-W, Au, Ni, NiCr, TaN on Al₂O₃, BeO, AlN
- Thermal Evaporation & Sputter Deposition
- Additive Process
- Etch-back Process



Thick Film Substrates

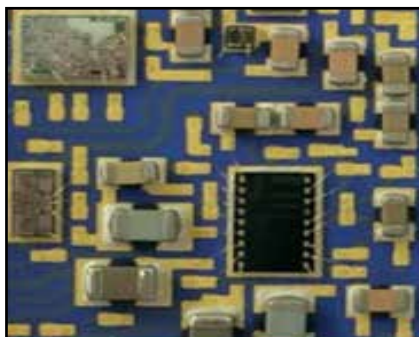
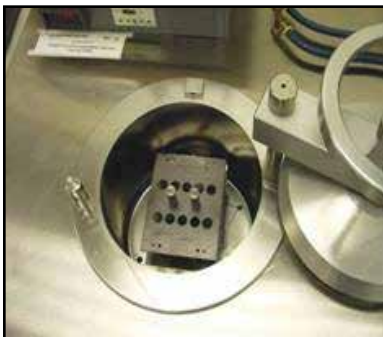
- Au/Ag on Al₂O₃, BeO, AlN
- Diffusion Patterning™
- Resistor Network
- Multiple Layers



COMPONENT & SUBSTRATE ATTACHMENT

Component Attachment

- Au/Ag on Al₂O₃, BeO, AlN
- Void-free Eutectic Die Attach
- Fully Automatic Pick and Place



Substrate Attachment

- Au/Ag on Al₂O₃, BeO, AlN
- DAP Vacuum Assisted Soldering Attach

WIRE BONDING



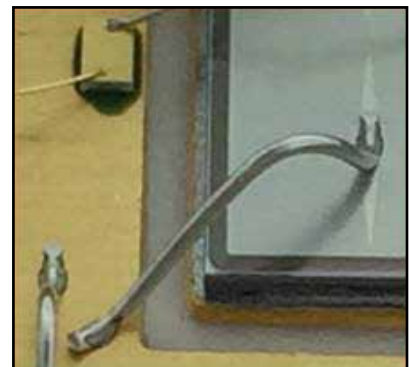
Automatic Wire bonding

- Hughes/Palomar
- Delvotec
- Orthodyne



Manual Wire bonding

- K&S
- High Bond
- Orthodyne



CLEANING & INSPECTION

Cleaning

- DL Aqueous
- Plasma
- Solvent



Inspection & Qualification

- XRF Scan
- Real Time X-ray
- Mechanical Shock
- Vibration (Random & Sine)
- Salt Atmosphere

ENVIRONMENTAL SCREENING & TESTING

Trim and Test

- Active Laser Trim
- Electrical Testing
- Fully Automated Test Systems



Hermetic Sealing & Burn-In

- Projection Weld & Seam Seal
- Pre-programmed Burn-in Cycling

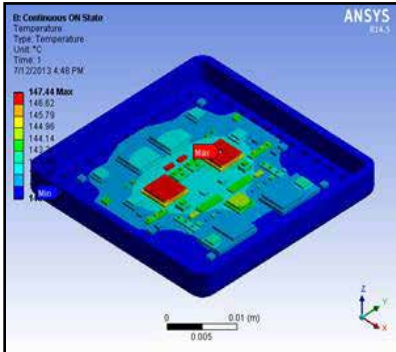


Environmental Stress Screening

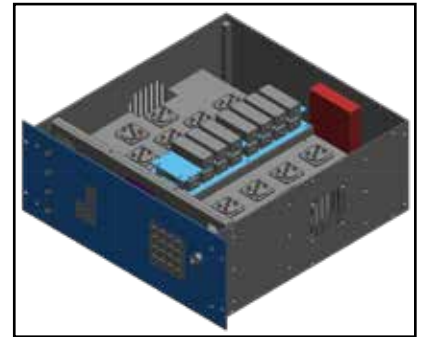
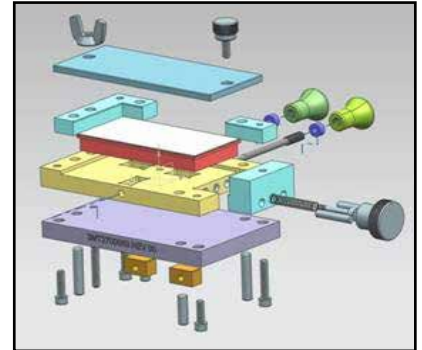
- Temperature Cycle
- Centrifuge/Acceleration
- Particle Impact Noise Detection
- Fine & Gross Leak Test



ENGINEERING SERVICES



- Circuit Design to Functional Specification
- Proof-of-Concept Design Verification
- ANSYS Thermal and Mechanical Stress
- Substrate Layout
- Test Fixture and Test Systems Design
- Assembly and Validation
- Burn-In Boards Design and Fabrication
- LabVIEW/TestStand Programming
- Element Evaluation
- SEM Analysis



HYBRID MICROCIRCUIT CERTIFICATION

Class H: Standard Military Quality Level

Class G: QML listing in accordance with 4.5.2.2



MIL-PRF-38534
HYBRID MICROCIRCUIT CERTIFICATION
 FOR
CLASS H
 IS HEREBY AWARDED TO

Teledyne Relays
12525 Daphne Avenue
Hawthorne, CA 90250

THIS CERTIFICATION IS VALID UNTIL TERMINATED BY WRITTEN NOTIFICATION FROM DLA LAND AND MARITIME. REFERENCE DLA LAND AND MARITIME LETTER VQ (VQH-21-035802) FOR DETAILS PERTAINING TO THIS CERTIFICATION.

WILLIAMS.EUGEN Digitally signed by
WILLIAMS.EUGENE.1180650748
E.1180650748 Date: 2021.01.15 14:42:24 -0500
 EUGENE WILLIAMS JR.
 Director Engineering & Technical Support Directorate (V)
 DLA, Land & Maritime



DEFENSE LOGISTICS AGENCY
 LAND AND MARITIME
 POST OFFICE BOX 3990
 COLUMBUS, OH 43218-3990

Mr. Andrew Camillo
 Teledyne Relays
 12525 Daphne Avenue
 Hawthorne, CA 90250-3384

April 25, 2024

Dear Mr. Camillo:

Re: Notification of Qualification, Hybrid Microcircuits MIL-PRF-38534, FSC 5962, VQH-24-038672, CAGE: 11532, Control Number 087895.

Initial qualification of your processes and materials is granted effective April 25, 2024 under the current issue of the Performance Specification MIL-PRF-38534, Hybrid Microcircuits, FSC 5962. This action is a result of successful qualification in accordance with test report number 38534-6025-21.

The processes and materials qualified by this report are identified in Your Hybrid Product Baseline (VQH-42H), dated March 28, 2024 for qualification device type 2296955-2 Rev. E. Your Qualified Manufacturers List (QML) listing will appear in Enclosure 1 and is subject to the conditions printed in Enclosure 2.

To maintain this listing, you are required to provide a retention report every twelve months. The standard reporting period is from May 1 through April 30 and your next report is due on April 30, 2025. This report is to include the processes and materials from this qualification. For additional information regarding the retention of qualification report, please see the DLA Land and Maritime-VQH published booklet Certification and Qualification Procedures for MIL-PRF-38534 Hybrid and MCML Microcircuits.

QML manufacturers shall notify the qualifying activity immediately after learning of a potential issuance of a GJEOP alert, problem advisory or major quality/reliability problem affecting QML products. Failure to provide prior notification may be grounds for removal from QML 38534.

Because we are held responsible for the accuracy and currency of this QML, please let us know if your company discontinues production utilizing this process.

If you have any questions concerning this letter, please contact Ms. Clare Jaquish at (614) 692-6826.

Sincerely,

DESUCH BRADLEY Digitally signed by
EYP.123012265
9 Date: 2024.04.25 15:43:07
BRADLEY P. DESLICH
 Chief
 Hybrid Devices Branch

RoHS and REACH CERTIFICATE OF COMPLIANCE

RoHS

It is hereby stated and certified that Teledyne Relays complies with the Restrictions on Hazardous Substances, RoHS 3 Directive (2024/232/EU) Directives to the extent herein:

Teledyne Relays does not use any of the Restricted Substances specified by the RoHS Directives (listed below) as components in our Electromechanical Relay, Coax Switch, and Industrial Solid-State Relay products. None of these substances are employed during any manufacturing process:

Lead
Mercury
Cadmium
Hexavalent Chromium
Polybrominated Biphenyls (PBB's)
Polybrominated Diphenyl Ethers (PBDE's)
2-ethylhexyl phthalate (DEHP)
Butyl benzyl phthalate (BBP)
Dibutyl phthalate (DBP)
Diisobutyl phthalate (DIBP)

However, upon request from the Customer, relay leads may be coated with lead solder, which contains 60% tin and 40% lead.

REACH

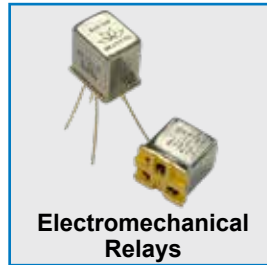
It is hereby stated and certified that Teledyne Relays complies with the Registration Evaluation Authorization and Restriction of Chemicals (REACH) Directives to the extent stated herein:

Teledyne Relays is a manufacturer of articles. Teledyne Relays has taken the initiative to review the (240) substances that are under consideration for treatment as Substances of Very High Concern (SVHC) candidates. Teledyne Relays confirmed that our relays do not contain any of the listed substances in concentration >0.1% weight per supplied article, substance or preparation weight.



For additional information please e-mail us at: relays@teledyne.com

About Us



**Electromechanical
Relays**



Coaxial Switches



Custom Matrix



**Industrial
Solid-State Relays**



**Military
Solid-State Relays**



Vertically Integrated



**Space Mission
Heritage**



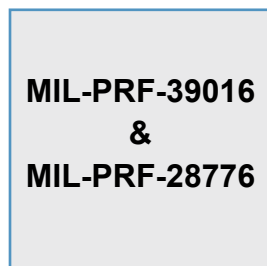
Mini Matrix



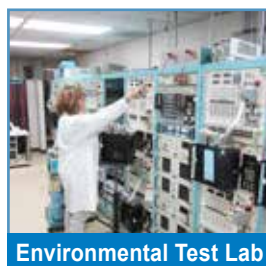
US Facility



**Hybrid Microcircuit
Devices**



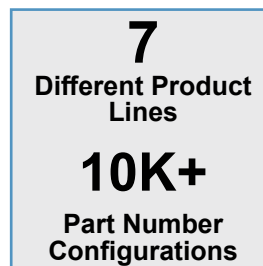
**MIL-PRF-39016
&
MIL-PRF-28776**



Environmental Test Lab



Value Added



**7
Different Product
Lines
10K+
Part Number
Configurations**



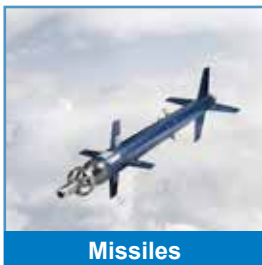
**MIL-PRF-38534
Class
H & K**



SMT Technology



**1000+
Defense Platforms
Served**



Missiles



Test & Instrumentation



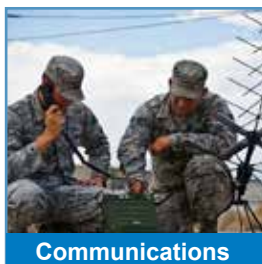
HI-REL Space



Defense



Electronic Warfare



Communications



Aerospace



Radar

Teledyne Relays
12525 Daphne Avenue, Hawthorne, CA 90250
Phone: (323) 777-0077
E-mail: relays@teledyne.com
www.teledynereleys.com



HEADQUARTERS

12525 Daphne Avenue
Hawthorne, CA 90250

Phone: (323) 777-0077 or (800) 284-7007

Fax: (323) 241-1287

EUROPE

9-13 Napier Road
Wardpark North
Cumbernauld G68 OEF
Scotland UK

Phone: +44 (0) 1236 453 124

Fax: +44 (0) 1236 780 651

E-mail: relays@teledyne.com

www.teledynerelays.com



TELEDYNE RELAYS
TELEDYNE COAX SWITCHES
Everywhere you look™